

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	Group Art Unit: N/A
A. K. Sarkhel et al.	
Serial No: N/A	Examiner: N/A
Filed: Herewith	Docket No. EN995038US5
Title: LEAD-FREE HIGH TIN TERNARY SOLDER ALLOY OF TIN, SILVER, AND BISMUTH	IBM Corporation Intellectual Property Law Department N50/040-4 1701 North Street Endicott, NY 13760

PRELIMINARY AMENDMENT

Honorable Commissioner of Patents and Trademarks  
Washington, DC 20231

Dear Sir:

Prior to initial examination on the merits, please amend the  
above-identified application as follows:

IN THE SPECIFICATION

On page 1, line 4, delete "The present invention" and add  
-- This application is a divisional application of serial no.  
09/216,042 which --.

IN THE CLAIMS

Please cancel claim 1-7, 11, and 12.

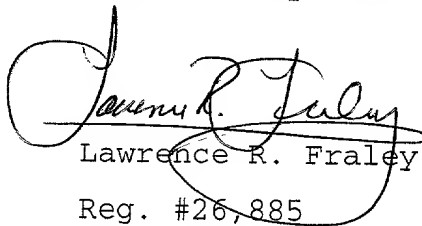
EN995038US5

REMARKS

Included are copies of the original PTO-1449 IDS, and PTO-892, notice of reference cited. Should the Examiner desire copies of said references, Applicants will supply them upon request.

If the Examiner believes that anything further is necessary in order to place the application in better condition for allowance, the Examiner is requested to contact Applicants' undersigned representative at the telephone number listed below.

Respectfully submitted,

  
Lawrence R. Fraley

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